Vishay Siliconix

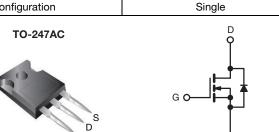
COMPLIANT

HALOGEN

FREE

E Series Power MOSFET

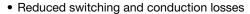
PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	700			
R _{DS(on)} max. at 25 °C (Ω)	V _{GS} = 10 V	0.072		
Q _g max. (nC)	273			
Q _{gs} (nC)	46			
Q _{gd} (nC)	79			
Configuration	Single			



N-Channel MOSFET

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)



- Ultra low gate charge (Q_a)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-247AC
Lead (Pb)-free and Halogen-free	SiHG47N65E-GE3

DADAMETER			se noted)	LIBAIT	LINIT	
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V_{DS}	650	V	
Gate-Source Voltage			V_{GS}	± 30	V	
Continuous Drain Current (T _J = 150 °C)	V _{GS} at 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$		47	A	
		T _C = 100 °C	ID	30		
Pulsed Drain Current ^a			I _{DM}	139		
Linear Derating Factor				3.3	W/°C	
Single Pulse Avalanche Energy b			E _{AS}	1410	mJ	
Maximum Power Dissipation			P _D	417	W	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C	
Drain-Source Voltage Slope	T _J = 125 °C		-1) / / -14	37	1//	
Reverse Diode dV/dt ^d		dV/dt	9	- V/ns		
Soldering Recommendations (Peak Temperature) c	for 10 s			300	°C	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 10 A.
- c. 1.6 mm from case.
- d. $I_{SD} \le I_D$, dI/dt = 100 A/ μs , starting $T_J = 25$ °C.



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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	40	°C/W	
Maximum Junction-to-Case (Drain)	R_{thJC}	-	0.3	C/VV	

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT			
Static		-							
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		650	-	-	V		
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, I _D = 1 mA		=.	0.70		V/°C		
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA		2	-	4	V		
Cata Carriaga Lagliaga	I _{GSS}	$V_{GS} = \pm 20 \text{ V}$		$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA
Gate-Source Leakage			V _{GS} = ± 30 V		-	± 1	μΑ		
Zava Cata Valtaga Dvain Cuwant		$V_{DS} = 650 \text{ V}, V_{GS} = 0 \text{ V}$		-	-	1	μА		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 520 \	V _{DS} = 520 V, V _{GS} = 0 V, T _J = 125 °C		-	25			
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 24 A	-	0.060	0.072	Ω		
Forward Transconductance	9 _{fs}	V _{DS} = 30 V, I _D = 24 A		-	16.7	-	S		
Dynamic					•				
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 100 V, f = 1 MHz		-	5682		pF		
Output Capacitance	C _{oss}			-	251	-			
Reverse Transfer Capacitance	C _{rss}			-	1	-			
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	V _{DS} = 0 V to 520 V, V _{GS} = 0 V		-	192	-			
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	665	-			
Total Gate Charge	Q_g		V _{GS} = 10 V I _D = 24 A, V _{DS} = 520 V		182	273	nC		
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V			46	-			
Gate-Drain Charge	Q _{gd}	7			79	-			
Turn-On Delay Time	t _{d(on)}	$V_{DD} = 520 \text{ V}, I_{D} = 6 \text{ A},$ $V_{GS} = 10 \text{ V}, R_{g} = 9.1 \Omega$		-	47	94	- ns		
Rise Time	t _r			-	87	131			
Turn-Off Delay Time	t _{d(off)}			-	156	234			
Fall Time	t _f			-	103	206			
Gate Input Resistance	R _g	f = 1 MHz, open drain		-	0.64	-	Ω		
Drain-Source Body Diode Characteristic	s						•		
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	47			
Pulsed Diode Forward Current	I _{SM}			-	-	139	A		
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 24 A, V _{GS} = 0 V		-	0.9	1.2	V		
Reverse Recovery Time	t _{rr}	T _J = 25 °C, I _F = I _S = 24 A, dl/dt = 100 A/µs, V _R = 25 V		-	753	1506	ns		
Reverse Recovery Charge	Q _{rr}			-	14	28	μC		
Reverse Recovery Current	I _{RRM}			_	28	_	A		

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



TYPCIAL CHARACTERISTICS (25 °C, unless otherwise noted)

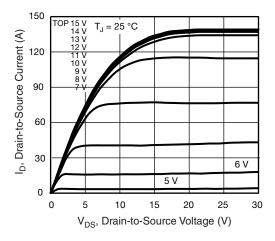


Fig. 1 - Typical Output Characteristics

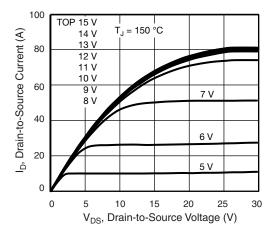


Fig. 2 - Typical Output Characteristics

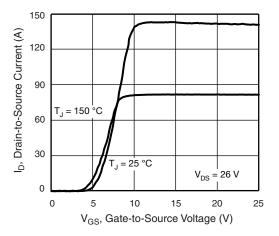


Fig. 3 - Typical Transfer Characteristics

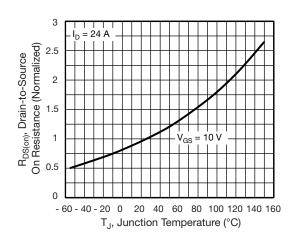


Fig. 4 - Normalized On-Resistance vs. Temperature

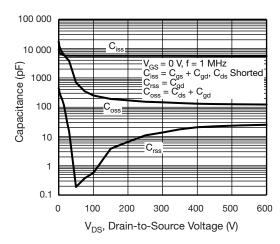


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

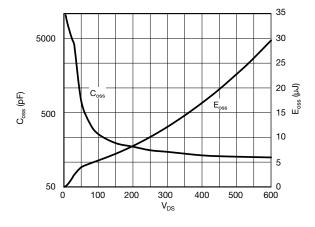


Fig. 6 - Coss and Eoss vs. VDS



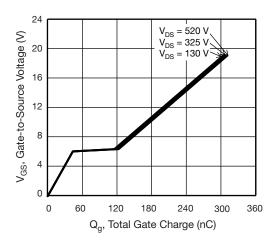


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

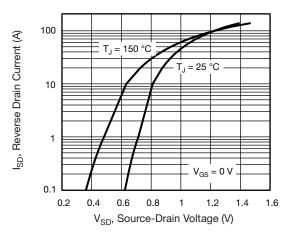


Fig. 8 - Typical Source-Drain Diode Forward Voltage

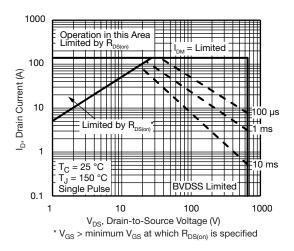


Fig. 9 - Maximum Safe Operating Area

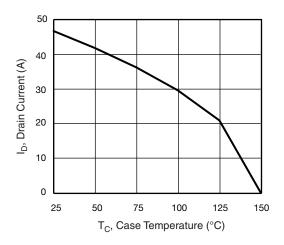


Fig. 10 - Maximum Drain Current vs. Case Temperature

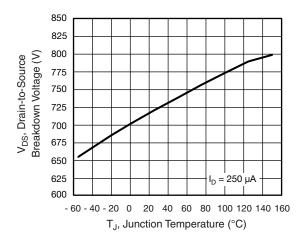


Fig. 11 - Temperature vs. Drain-to-Source Voltage



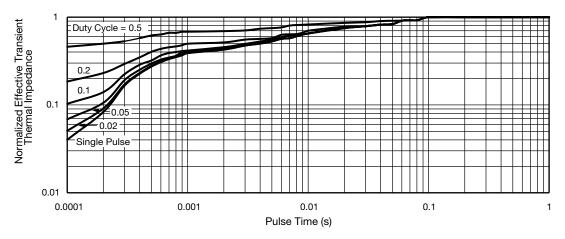


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

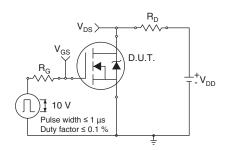


Fig. 13 - Switching Time Test Circuit

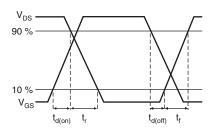


Fig. 14 - Switching Time Waveforms

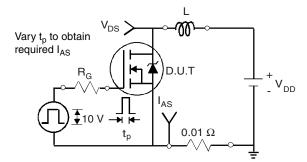


Fig. 15 - Unclamped Inductive Test Circuit

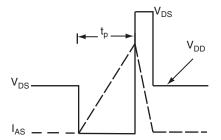


Fig. 16 - Unclamped Inductive Waveforms

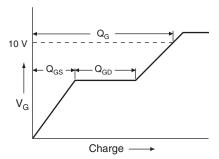


Fig. 17 - Basic Gate Charge Waveform

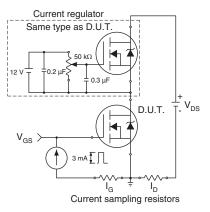
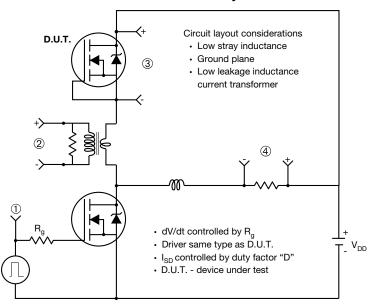


Fig. 18 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



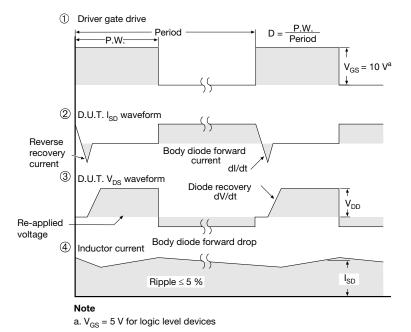


Fig. 19 - For N-Channel

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